

SMD Type 970nm Infrared Emitter

Features

Small double-end package

- Viewing Angle = $\pm 37.5^{\circ}$
- High reliability
- Good spectral matching to Si photo detector
- RoHS compliance

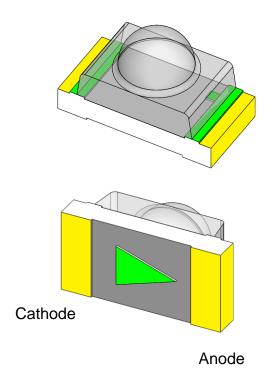
Applications

Infrared sensor

Description

The IRP1608XB09-H5 is a GaAlAs infrared LED housed in a miniature SMD package. The device has a peak wavelength of 970nm LED spectrally matched with phototransistor or photodiode.

Package Outline



Schematic

Cathode
$$-$$
 Anode



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Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
l _F	Continuous Forward Current	70	mA	
I _{FP}	Peak Forward Current	1	Α	1
VR	Reverse Voltage	5	V	
T _{opr}	Operating Temperature	-40 ~ +85	°C	
T _{stg}	Storage Temperature	-40 ~ +100	°C	
T _{sol}	Soldering Temperature	260	°C	2
P _D	Power Dissipation at(or below) 25°C Free Air Temperature	126	mW	

Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

Optical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
la	Padient Intensity	I _F =20mA	2.5	4.5	-	mW/sr	
le Radiant Intensity		I _F =70mA	-	15	-	11100/51	
λр	Peak Wavelength	I _F =20mA	-	970	-	nm	
Δλ	Spectral Bandwidth	I _F =20mA	-	25	-	nm	
θ1/2	Angle of Half Intensity	I _F =20mA	-	±37.5	-	deg	

Electrical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
\/_	Forward Voltage	I _F =20mA	1.15	1.30	1.5	\/	
V _F		I _F =70mA	1.25	1.45	1.8]	
I _R	Reverse Current	V _R =5V	-	-	10	μΑ	

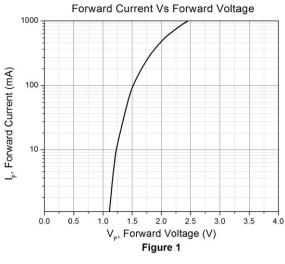
Notes:

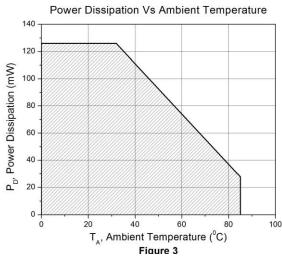
- 1. I_{FP} Conditions--Pulse Width \leq 100 μ s and Duty \leq 1%.
- 2. Soldering time≦5 seconds.

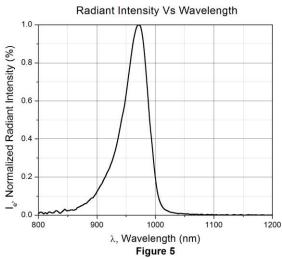


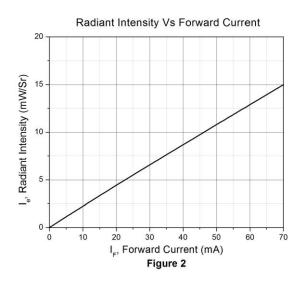
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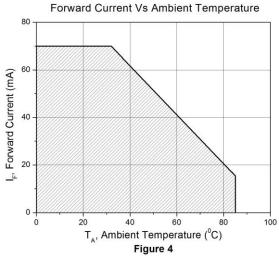
Typical Characteristic Curves









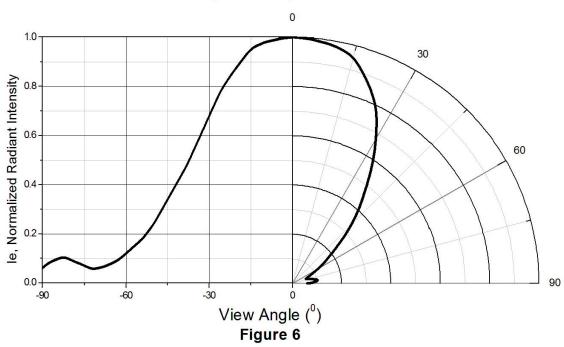




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Typical Characteristic Curves

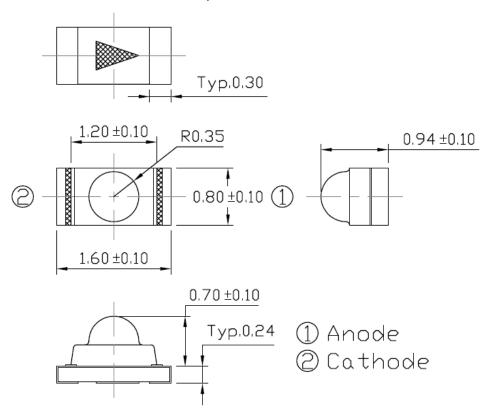
Angular Displacement



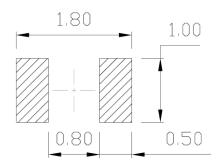


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Package Dimension All dimensions are in mm, unless otherwise stated



Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



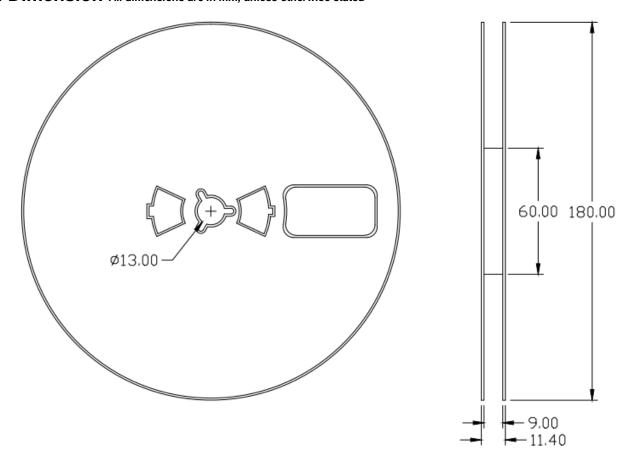
Ordering Information

Part Number	Description	Quantity
IRP1608XB09-H5	Tape & Reel	4000 pcs

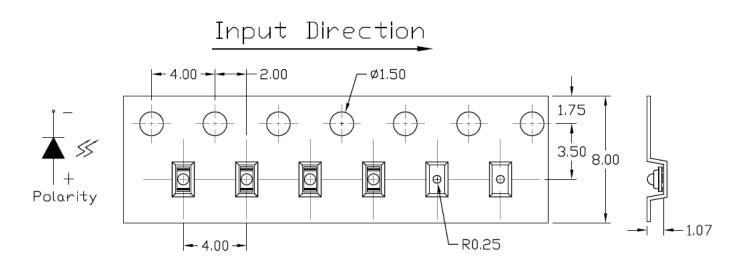


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Reel Dimension All dimensions are in mm, unless otherwise stated



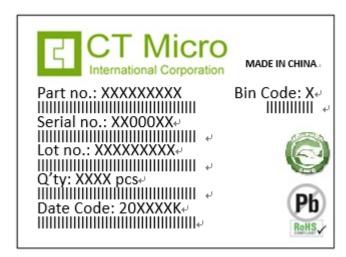
Tape Dimension All dimensions are in mm, unless otherwise stated





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Label Form Specification



Part no: CTM Production Number Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date

Bin Code: le Ranks

MADE IN CHINA: Production Place

Storage Condition

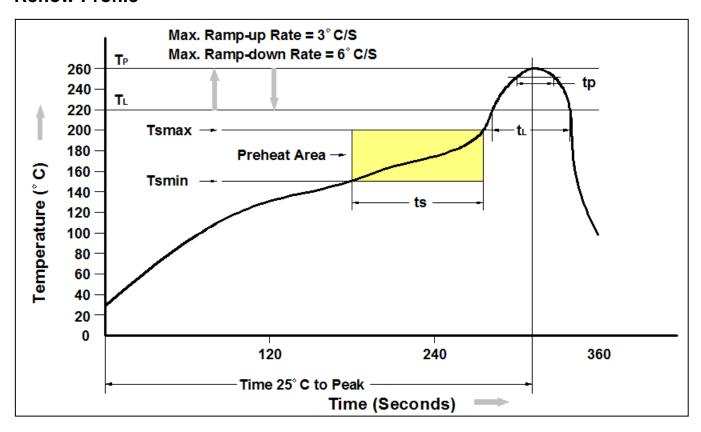
- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 168h at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.





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Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t₂)	3°C/second max.
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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